

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Rainer POPP</td> <td>12/15/2008</td> </tr> <tr> <td>Markus GRUBER</td> <td>12/15/2008</td> </tr> </tbody> </table>		Name	Execution Date	Rainer POPP	12/15/2008	Markus GRUBER	12/15/2008
Name	Execution Date						
Rainer POPP	12/15/2008						
Markus GRUBER	12/15/2008						
RECEIVING PARTY DATA							
Name:	SEMIKRON Elektronik GmbH & Co. KG						
Street Address:	Sigmundstr. 200						
City:	Nurnberg						
State/Country:	GERMANY						
Postal Code:	90431						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12313125</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12313125		
Property Type	Number						
Application Number:	12313125						
CORRESPONDENCE DATA							
Fax Number:	(212)972-5487						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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ATTORNEY DOCKET NUMBER:	5454-49						
NAME OF SUBMITTER:	Roger S. Thompson						
Total Attachments: 2 source=5454-49-Assignment#page1.tif source=5454-49-Assignment#page2.tif							

CH \$40.00 12313125

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned, **Rainer POPP, Markus GRUBER** (hereinafter referred to as "ASSIGNOR"):

Hereby sell, assign and transfer to **SEMIKRON Elektronik GmbH & Co. KG** (hereinafter referred to as "ASSIGNEE"), a corporation of Germany, having a place of business at Sigmundstr. 200, 90431 Nürnberg, Germany, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to the invention which is disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and which is entitled

POWER SEMICONDUCTOR MODULE HAVING A SUBSTRATE AND A PRESSURE DEVICE


and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on said invention; and in and to all original, reissued and other patents and certificates of invention which have been or shall be issued in the United States and all foreign countries on said invention;

Agree that said Assignee may apply for and receive Letters Patent for said invention in its own name, and that, when requested, without further consideration from or charge to, but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on said invention; execute


all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said invention and for vesting title to said invention and all applications for patents and all patents on said invention, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.


Date: 12/15/2008
month/day/year



Rainer POPP

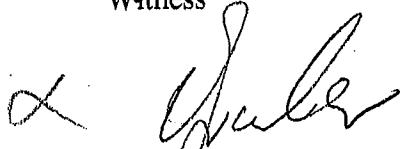


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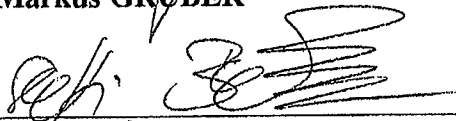


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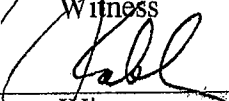
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Markus GRUBER



Witness



Witness